



Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V)	Ι _{R(MAX)} (μΑ)
800	1	1.85	5

Description and Applications

The US1KSAFS is a rectifier packaged in the SMA-FS package. Providing ultra-fast recovery time for high efficiency, this device is ideal for use in applications such as:

- Power Supply
- Smartphone Chargers
- Inverters

Notes:

Free Wheeling Diodes

1.0A SURFACE MOUNT ULTRA-FAST RECTIFIER

Features and Benefits

- Glass Passivated Die Construction
- Ideally Suited for Use in Very High Frequency Switching
- Ultra-Fast Recovery Time for High Efficiency
- Soft Recovery Characteristics
- Surge Overload Rating to 30A Peak
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SMA-FS
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.033 grams (Approximate)

SMA-FS



Schematic View

Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
US1KSAFS-13	Commercial	SMA-FS	10,000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Top View

Marking Information



U1KS = Product Type Marking Code D!! = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 6 for 2016) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 5)	V _{RRM} V _{RWM} V _R	800	V
RMS Reverse Voltage	V _{R(RMS)}	560	V
Average Rectified Output Current $@T_A = +40^\circ$	C Io	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	30	A
Maximum Full Load Reverse Current, Full Cycle Average, 0.375"(9.5mm) Length at $T_A = +55^{\circ}C$	I _{R(AV)}	100	μA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 8)	R _{0JC}	25	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 8)	R _{θJA}	150	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Reverse Breakdown Voltage (Note 5)	@I _R = 5µA	V _{(BR)R}	800	V
Maximum Forward Voltage Drop	@I _F = 1.0A	VF	1.85	V
Peak Reverse Current	@T _A = +25°C	1-	5.0	
at Rated DC Blocking Voltage (Note 5)	@T _A = +100°C	IR	50	μA
Maximum Reverse Recovery Time (Note 6)		t _{RR}	75	ns
Typical Total Capacitance (Note 7)		Ст	5	pF

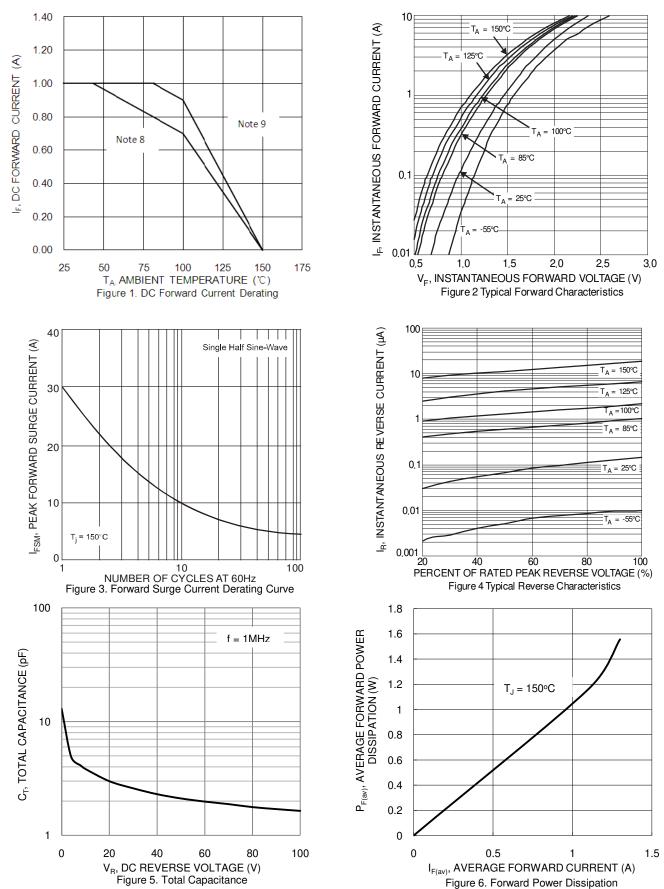
5. Short duration pulse test used to minimize self-heating effect.

Stort duration puse test deed infimitize sen-fleating energi.
Measured with I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A. See figure 7.
Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
Device mounted on FR-4 substrate, 1"x1", 2oz, single-sided, PC boards with 0.1"x0.15" copper pad.
Device mounted on FR-4 substrate, 0.4"x0.5", 2oz, single-sided, PC boards with 0.2"x0.25" copper pad.

Notes:



US1KSAFS



NEW PRODUCT

US1KSAFS Document number: DS38879 Rev. 2 - 2

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US1KSAFS

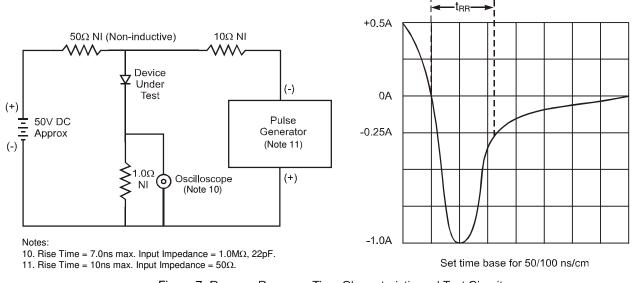
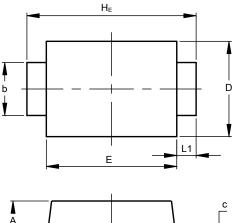


Figure 7. Reverse Recovery Time Characteristic and Test Circuit

SMA-FS

Package Outline Dimensions

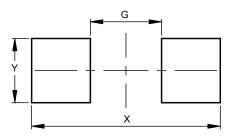
Please see http://www.diodes.com/package-outlines.html for the latest version.





Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
G	2.10
Х	5.30
Y	1.77

SMA-FS				
Dim	Min	Max		
Α	0.90	1.20		
b	1.30	1.50		
С	0.11	0.21		
D	2.30	2.70		
E	3.30	3.70		
HE	4.40	4.80		
L	0.70	1.10		
L1	0.45	0.65		
All Dimensions in mm				

US1KSAFS Document number: DS38879 Rev. 2 - 2 SMA-FS



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